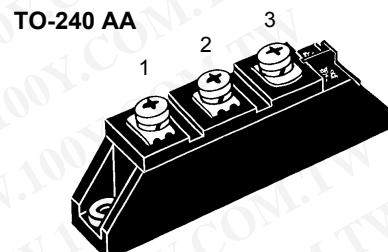


Fast Recovery Epitaxial Diode (FRED) Module

Preliminary data

V_{RSM} V	V_{RRM} V	Type	MEA75-12 DA	MEK 75-12 DA	MEE 75-12 DA
1200	1200		1 2 3	1 2 3	1 2 3

$V_{RRM} = 1200\text{ V}$
 $I_{FAV} = 75\text{ A}$
 $t_{rr} = 250\text{ ns}$



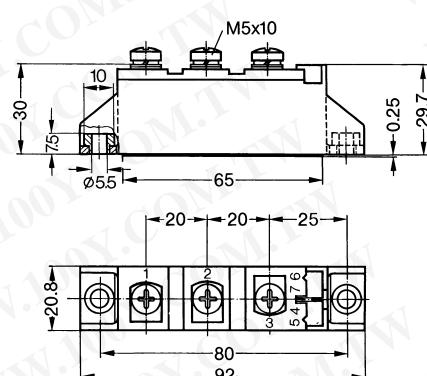
Symbol	Test Conditions	Maximum Ratings		
I_{FRMS}	$T_{case} = 75^\circ\text{C}$	107	A	
I_{FAV}	$T_{case} = 75^\circ\text{C}$; rectangular, $d = 0.5$	75	A	
I_{FRM}	$t_p < 10\ \mu\text{s}$; rep. rating, pulse width limited by T_{VJM}	TBD	A	
I_{FSM}	$T_{VJ} = 45^\circ\text{C}$; $t = 10\ \text{ms}$ (50 Hz), sine $t = 8.3\ \text{ms}$ (60 Hz), sine	1200	A	
		1300	A	
	$T_{VJ} = 150^\circ\text{C}$; $t = 10\ \text{ms}$ (50 Hz), sine $t = 8.3\ \text{ms}$ (60 Hz), sine	1080	A	
		1170	A	
I^2t	$T_{VJ} = 45^\circ\text{C}$; $t = 10\ \text{ms}$ (50 Hz), sine $t = 8.3\ \text{ms}$ (60 Hz), sine	7200	A^2s	
		7100	A^2s	
	$T_{VJ} = 150^\circ\text{C}$; $t = 10\ \text{ms}$ (50 Hz), sine $t = 8.3\ \text{ms}$ (60 Hz), sine	5800	A^2s	
		5700	A^2s	
T_{VJ}		-40...+150	$^\circ\text{C}$	
T_{stg}		-40...+125	$^\circ\text{C}$	
T_{Hmax}		110	$^\circ\text{C}$	
P_{tot}	$T_{case} = 25^\circ\text{C}$	280	W	
V_{ISOL}	50/60 Hz, RMS $t = 1\ \text{min}$ $I_{ISOL} \leq 1\ \text{mA}$ $t = 1\ \text{s}$	3000	$\text{V}_\text{~}$	
		3600	$\text{V}_\text{~}$	
M_d	Mounting torque (M5) Terminal connection torque (M5)	2.50-4/22-35	Nm/lb.in	
d_s	Creep distance on surface	12.7	mm	
d_a	Strike distance through air	9.6	mm	
a	Maximum allowable acceleration	50	m/s^2	
Weight		90	g	

Symbol	Test Conditions	Characteristic Values (per diode)		
		typ.	max.	
I_R	$T_{VJ} = 25^\circ\text{C}$ $V_R = V_{RRM}$ $T_{VJ} = 25^\circ\text{C}$ $V_R = 0.8 \cdot V_{RRM}$ $T_{VJ} = 125^\circ\text{C}$ $V_R = 0.8 \cdot V_{RRM}$	2 0.5 34	mA mA mA	
V_F	$I_F = 100\text{ A}$; $T_{VJ} = 125^\circ\text{C}$ $T_{VJ} = 25^\circ\text{C}$ $I_F = 300\text{ A}$; $T_{VJ} = 125^\circ\text{C}$ $T_{VJ} = 25^\circ\text{C}$	1.85 2.17 2.58 2.64	V V V V	
V_{TO}	For power-loss calculations only	1.48 3.65	V $\text{m}\Omega$	
r_T				
R_{thJH}	DC current	0.550	K/W	
R_{thJC}	DC current	0.450	K/W	
t_{rr} I_{RM}	$I_F = 150\text{ A}$ $V_R = 600\text{ V}$ $-di/dt = 200\text{ A}/\mu\text{s}$	$T_{VJ} = 100^\circ\text{C}$ $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 100^\circ\text{C}$	250 22 33	ns A A

Data according to IEC 60747

IXYS reserves the right to change limits, test conditions and dimensions

Dimensions in mm (1 mm = 0.0394")



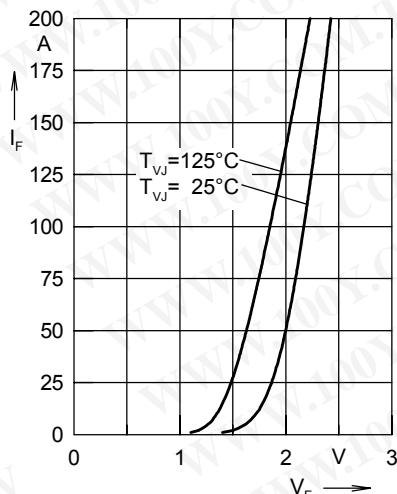


Fig. 1 Forward current I_F versus voltage drop V_F per leg

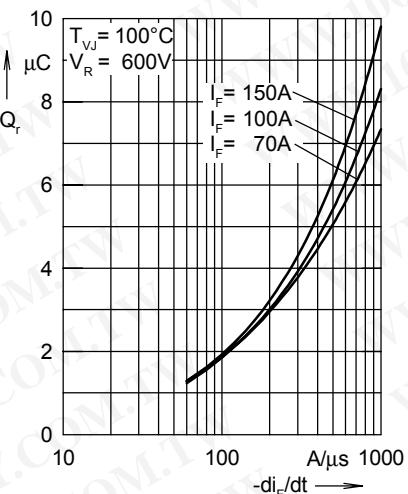


Fig. 2 Reverse recovery charge Q_r versus $-di_F/dt$

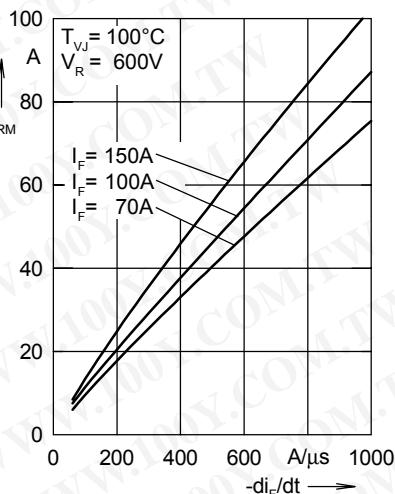


Fig. 3 Peak reverse current I_{RM} versus $-di_F/dt$

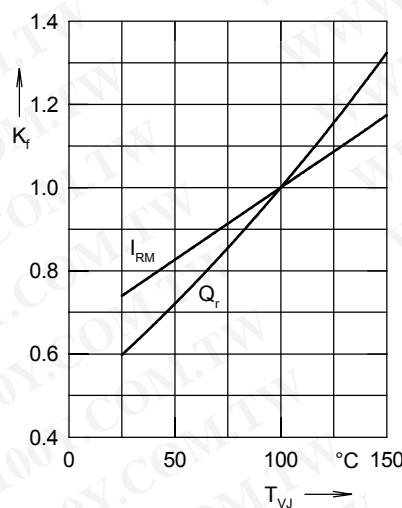


Fig. 4 Dynamic parameters Q_r , I_{RM} versus junction temperature T_{VJ}

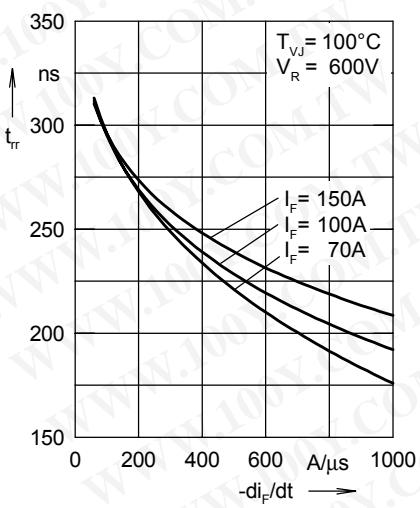


Fig. 5 Recovery time t_{rr} versus $-di_F/dt$

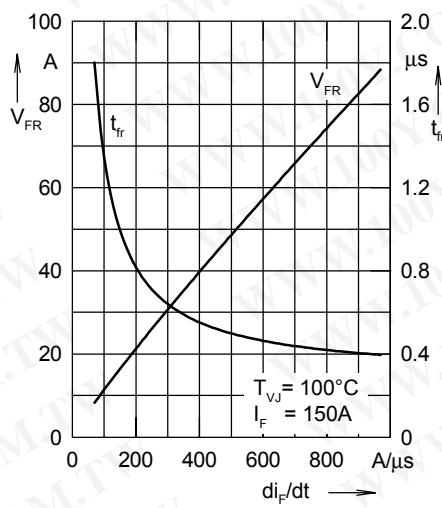


Fig. 6 Peak forward voltage V_{FR} and t_{rr} versus di_F/dt

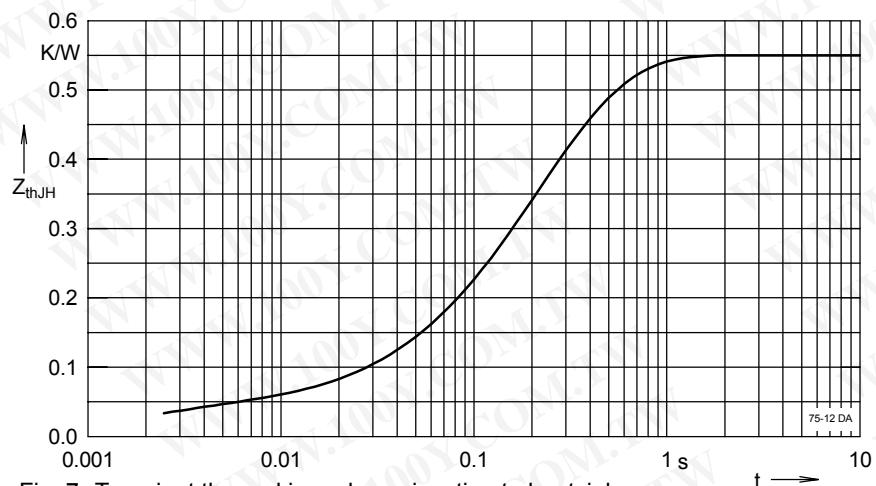


Fig. 7 Transient thermal impedance junction to heatsink

Constants for Z_{thJH} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.037	0.002
2	0.138	0.134
3	0.093	0.25
4	0.282	0.274